

Integrated Device Technology, Inc. 6024 Silver Creek Valley Road, San Jose, CA 95138

<b>PRODUCT/PROCESS</b>	CHANGE	NOTICE	(PCN)
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PCN #: F1308-01 DATE: Product Affected: TSI721-16GIL TSI721-16GCLY TSI721-16GILY Date Effective: January 1, 2014 Contact: IDT PCN DESK	October 1, 2013	<ul> <li>Product</li> <li>Back Ma</li> <li>Date Co</li> <li>Other</li> </ul>	Mark Ch ark	IING CHANGED DEVICES: aanged in orderable part# es	
Contact:IDT PCN DESKE-mail:pcndesk@idt.com			Contact your loca	al sales representative for	
sample and datasheet requests.         DESCRIPTION AND PURPOSE OF CHANGE:         Die Technology         Wafer Fabrication Process       This notification is to advise our customers that IDT has qualified a new die revision to address the device errata. The device die revision will change from Rev A0 to Rev A1.         Material       There will be change in ordering part number and device top mark. There is no change to die technology/process. The new die revision is fully hardware and software compatible with the previous revision.         Data Sheet       Please see attachment for details.					
RELIABILITY/QUALIFICATION SUMMARY:         There is no change in die technology/process.         CUSTOMER ACKNOWLEDGMENT OF RECEIPT:         IDT records indicate that you require written notification of this change. Please use the acknowledgement below or E-Mail to grant approval or request additional information. If IDT does not receive acknowledgement within 30 days of this notice it will be assumed that this change is acceptable.         IDT reserves the right to ship either version manufactured after the process change effective date until the inventory on the earlier version has been depleted.					
Customer:	□	Approv	al for shipm	ents prior to effective date.	
Name/Date:	E-I	Mail Address:			
Title:	Ph	one # /Fax #:			
CUSTOMER COMMENTS:					
IDT ACKNOWLEDGMENT OF RECEIPT:					
RECD. BY:		DATE:			



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## **PRODUCT/PROCESS CHANGE NOTICE (PCN)**

## ATTACHMENT I - PCN #: F1308-01

PCN Type: Die Revision Change

No

Data Sheet Change:

## **Detail of Change:**

This notification is to advise our customers that IDT has qualified a new die revision to address the device errata. The device die revision will change from Rev A0 to Rev A1.

There will be change in the ordering part number and device top mark. There is no change to die technology/process. The new die revision is fully hardware and software compatible with the previous revision.

The new die revision will address the known errata item as shown in Table 1.

Errata Item	Effected Devices	"A0" Revision	"A1" Revision
RapidIO line loopback does not support arbitrary data	All	Random 10b data cannot be looped back by the RapidIO port	Fixed
PCIe MSIXTBL and MSIXPBA incorrect default values	All	Software will not configure MSI-X interrupt table functionality correctly	Fixed
BDMA response timeouts cause a resource leak	All	The BDMA will stall and cause a network failure	Fixed

Table 1

Note: please refer to the device errata document for full detail.

Table 2		
Old Ordering Part Number	New Ordering Part Number	
TSI721-16GIL	TSI721A1-16GIL	
TSI721-16GCLY	TSI721A1-16GCLY	
TSI721-16GILY	TSI721A1-16GILY	

## Table 2